



Please note that Cypress is an Infineon Technologies Company.

The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content

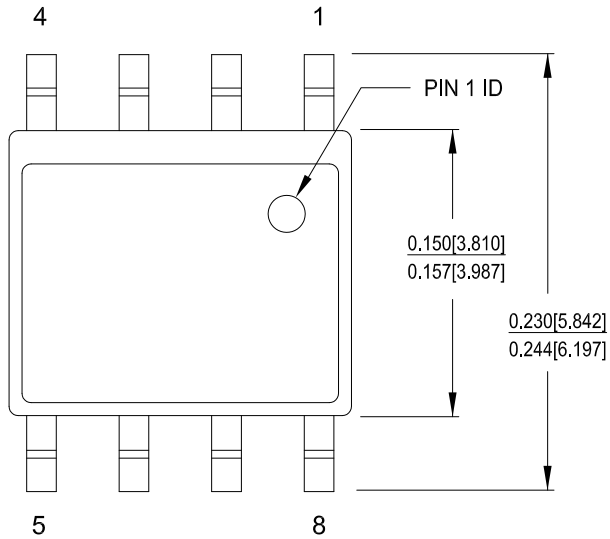
The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

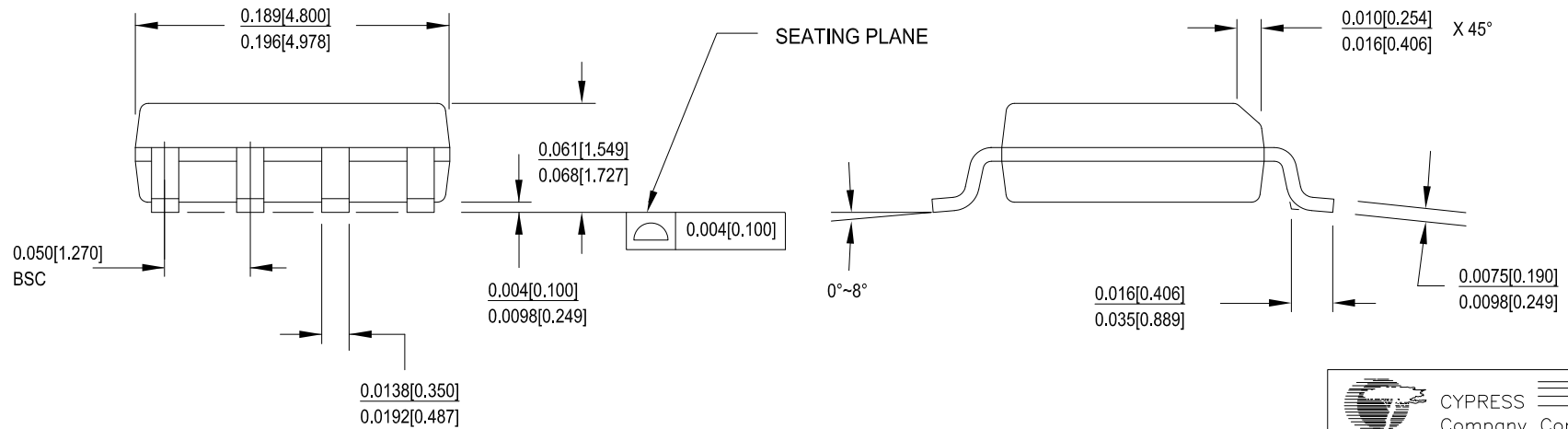
Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

8 Lead (150 Mil) SOIC - S08

1. DIMENSIONS IN INCHES[MM] MIN. MAX.
2. PIN 1 ID IS OPTIONAL, ROUND ON SINGLE LEADFRAME RECTANGULAR ON MATRIX LEADFRAME
3. REFERENCE JEDEC MS-012
4. PACKAGE WEIGHT 0.07gms




PART #	
S08.15	STANDARD PKG
SZ08.15	LEAD FREE PKG
SW8.15	LEAD FREE PKG



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PACKAGE CODE(S)
SZ815
S0815
SW815

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TITLE PACKAGE OUTLINE, 8LD SOIC 150 MILS
S0815/SZ815/SW815

SPEC. NO. 51-85066
SCALE 1:1

REV. *1
SHEET 1 OF 2

REV.	ECN No.	Origin of Change	Description of Change
**	1127	N/A	NEW RELEASE
*A	49414	N/A	CHG. TITLE
*B	125107	N/A	ADD [MM] DIMENSIONS
*C	128913	N/A	ADD JEDEC #/ ADD SZ PART #/ ADD PKG. WEIGHT/ CHG. STANDARD PART # TO S08.15
*D	2835671	QAD	Changed template, & title from 8LD (150 MIL) SOIC PKG OUTLINE to PACKAGE OUTLINE, 8LD SOIC 150 MILS S08.15/SZ08.15.
*E	3278498	QADTMP1	NO CHANGE. SUNSET REVIEW.
*F	3949392	JVP	ADDED SW815 PACKAGE CODE / UPDATE SPEC TITLE
*G	4600939	ROWI	SUNSET REVIEW, NO CHANGE.
*H	4872952	XANC	MOVED PIN 1 ID LOCATION.
*I	5815319	KOTA	Changed coplanarity value from 0.102 to 0.100



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TITLE PACKAGE OUTLINE, 8LD SOIC 150 MILS
S0815/SZ815/SW815

SPEC. NO. 51-85066 REV. *I

SCALE 1:1 SHEET 2 OF 2

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